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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	8MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	16KB (8K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17lc44-08-pq

2.0 PIC17C4X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC17C4X Product Selection System section at the end of this data sheet. When placing orders, please use the "PIC17C4X Product Identification System" at the back of this data sheet to specify the correct part number.

For the PIC17C4X family of devices, there are four device "types" as indicated in the device number:

1. **C**, as in PIC17**C**42. These devices have EPROM type memory and operate over the standard voltage range.
2. **LC**, as in PIC17**LC**42. These devices have EPROM type memory, operate over an extended voltage range, and reduced frequency range.
3. **CR**, as in PIC17**CR**42. These devices have ROM type memory and operate over the standard voltage range.
4. **LCR**, as in PIC17**LCR**42. These devices have ROM type memory, operate over an extended voltage range, and reduced frequency range.

2.1 UV Erasable Devices

The UV erasable version, offered in Cerdip package, is optimal for prototype development and pilot programs.

The UV erasable version can be erased and reprogrammed to any of the configuration modes. Microchip's PRO MATE™ programmer supports programming of the PIC17C4X. Third party programmers also are available; refer to the *Third Party Guide* for a list of sources.

2.2 One-Time-Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers expecting frequent code changes and updates.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must also be programmed.

2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

2.4 Serialized Quick-Turnaround Production (SQTPSM) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password or ID number.

ROM devices do not allow serialization information in the program memory space.

For information on submitting ROM code, please contact your regional sales office.

2.5 Read Only Memory (ROM) Devices

Microchip offers masked ROM versions of several of the highest volume parts, thus giving customers a low cost option for high volume, mature products.

For information on submitting ROM code, please contact your regional sales office.

5.3 Peripheral Interrupt Request Register (PIR)

This register contains the individual flag bits for the peripheral interrupts.

Note: These bits will be set by the specified condition, even if the corresponding interrupt enable bit is cleared (interrupt disabled), or the GLINTD bit is set (all interrupts disabled). Before enabling an interrupt, the user may wish to clear the interrupt flag to ensure that the program does not immediately branch to the peripheral interrupt service routine.

FIGURE 5-4: PIR REGISTER (ADDRESS: 16h, BANK 1)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R - 1	R - 0
RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF
bit7							bit0
<p>bit 7: RBIF: PORTB Interrupt on Change Flag bit 1 = One of the PORTB inputs changed (Software must end the mismatch condition) 0 = None of the PORTB inputs have changed</p> <p>bit 6: TMR3IF: Timer3 Interrupt Flag bit If Capture1 is enabled ($CA1/\overline{PR3} = 1$) 1 = Timer3 overflowed 0 = Timer3 did not overflow If Capture1 is disabled ($CA1/\overline{PR3} = 0$) 1 = Timer3 value has rolled over to 0000h from equalling the period register (PR3H:PR3L) value 0 = Timer3 value has not rolled over to 0000h from equalling the period register (PR3H:PR3L) value</p> <p>bit 5: TMR2IF: Timer2 Interrupt Flag bit 1 = Timer2 value has rolled over to 0000h from equalling the period register (PR2) value 0 = Timer2 value has not rolled over to 0000h from equalling the period register (PR2) value</p> <p>bit 4: TMR1IF: Timer1 Interrupt Flag bit If Timer1 is in 8-bit mode ($T16 = 0$) 1 = Timer1 value has rolled over to 0000h from equalling the period register (PR) value 0 = Timer1 value has not rolled over to 0000h from equalling the period register (PR2) value If Timer1 is in 16-bit mode ($T16 = 1$) 1 = TMR1:TMR2 value has rolled over to 0000h from equalling the period register (PR1:PR2) value 0 = TMR1:TMR2 value has not rolled over to 0000h from equalling the period register (PR1:PR2) value</p> <p>bit 3: CA2IF: Capture2 Interrupt Flag bit 1 = Capture event occurred on RB1/CAP2 pin 0 = Capture event did not occur on RB1/CAP2 pin</p> <p>bit 2: CA1IF: Capture1 Interrupt Flag bit 1 = Capture event occurred on RB0/CAP1 pin 0 = Capture event did not occur on RB0/CAP1 pin</p> <p>bit 1: TXIF: USART Transmit Interrupt Flag bit 1 = Transmit buffer is empty 0 = Transmit buffer is full</p> <p>bit 0: RCIF: USART Receive Interrupt Flag bit 1 = Receive buffer is full 0 = Receive buffer is empty</p>							
<p>R = Readable bit W = Writable bit -n = Value at POR reset</p>							

6.7 Program Counter Module

The Program Counter (PC) is a 16-bit register. PCL, the low byte of the PC, is mapped in the data memory. PCL is readable and writable just as is any other register. PCH is the high byte of the PC and is not directly addressable. Since PCH is not mapped in data or program memory, an 8-bit register PCLATH (PC high latch) is used as a holding latch for the high byte of the PC. PCLATH is mapped into data memory. The user can read or write PCH through PCLATH.

The 16-bit wide PC is incremented after each instruction fetch during Q1 unless:

- Modified by GOTO, CALL, LCALL, RETURN, RETLW, or RETFIE instruction
- Modified by an interrupt response
- Due to destination write to PCL by an instruction

“Skips” are equivalent to a forced NOP cycle at the skipped address.

Figure 6-11 and Figure 6-12 show the operation of the program counter for various situations.

FIGURE 6-11: PROGRAM COUNTER OPERATION

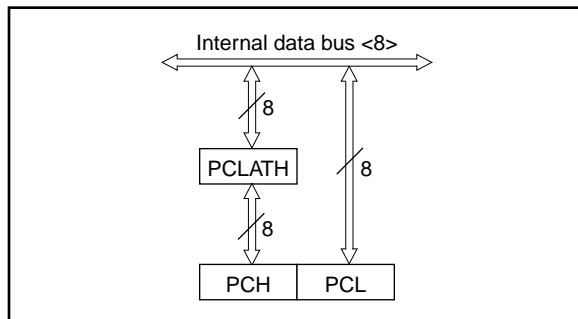
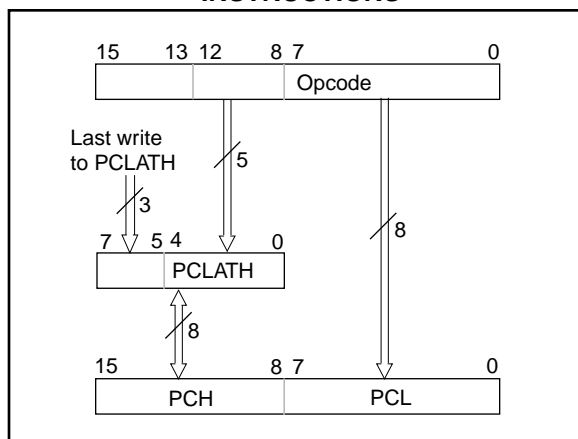


FIGURE 6-12: PROGRAM COUNTER USING THE CALL AND GOTO INSTRUCTIONS



Using Figure 6-11, the operations of the PC and PCLATH for different instructions are as follows:

- LCALL instructions:**
An 8-bit destination address is provided in the instruction (opcode). PCLATH is unchanged.
PCLATH → PCH
Opcode<7:0> → PCL
- Read instructions on PCL:**
Any instruction that reads PCL.
PCL → data bus → ALU or destination
PCH → PCLATH
- Write instructions on PCL:**
Any instruction that writes to PCL.
8-bit data → data bus → PCL
PCLATH → PCH
- Read-Modify-Write instructions on PCL:**
Any instruction that does a read-write-modify operation on PCL, such as ADDWF PCL.
Read: PCL → data bus → ALU
Write: 8-bit result → data bus → PCL
PCLATH → PCH
- RETURN instruction:**
PCH → PCLATH
Stack<MRU> → PC<15:0>

Using Figure 6-12, the operation of the PC and PCLATH for GOTO and CALL instructions is as follows:

CALL, GOTO instructions:

A 13-bit destination address is provided in the instruction (opcode).

Opcode<12:0> → PC <12:0>

PC<15:13> → PCLATH<7:5>

Opcode<12:8> → PCLATH <4:0>

The read-modify-write only affects the PCL with the result. PCH is loaded with the value in the PCLATH. For example, ADDWF PCL will result in a jump within the current page. If PC = 03F0h, WREG = 30h and PCLATH = 03h before instruction, PC = 0320h after the instruction. To accomplish a true 16-bit computed jump, the user needs to compute the 16-bit destination address, write the high byte to PCLATH and then write the low value to PCL.

The following PC related operations do not change PCLATH:

- LCALL, RETLW, and RETFIE instructions.
- Interrupt vector is forced onto the PC.
- Read-modify-write instructions on PCL (e.g. BSF PCL).

6.8 Bank Select Register (BSR)

The BSR is used to switch between banks in the data memory area (Figure 6-13). In the PIC17C42, PIC17CR42, and PIC17C42A only the lower nibble is implemented. While in the PIC17C43, PIC17CR43, and PIC17C44 devices, the entire byte is implemented. The lower nibble is used to select the peripheral register bank. The upper nibble is used to select the general purpose memory bank.

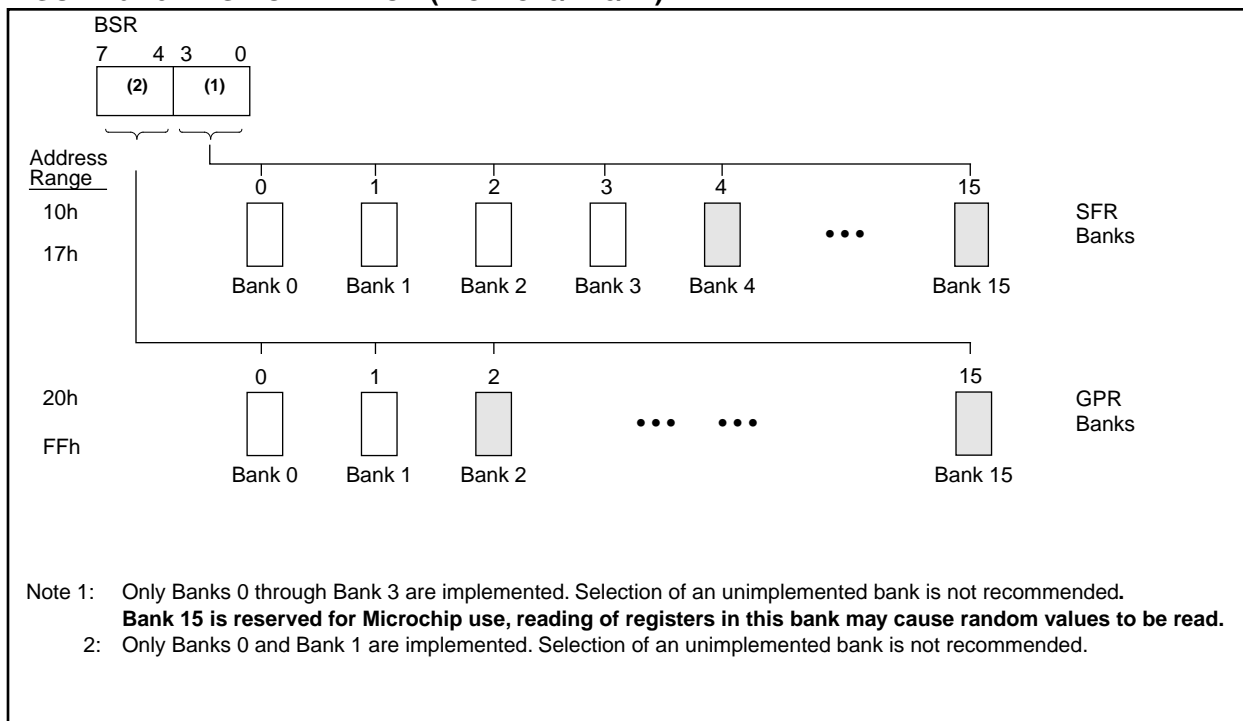
All the Special Function Registers (SFRs) are mapped into the data memory space. In order to accommodate the large number of registers, a banking scheme has been used. A segment of the SFRs, from address 10h to address 17h, is banked. The lower nibble of the bank select register (BSR) selects the currently active "peripheral bank." Effort has been made to group the peripheral registers of related functionality in one bank. However, it will still be necessary to switch from bank to bank in order to address all peripherals related to a single task. To assist this, a `MOVLB` bank instruction is in the instruction set.

For the PIC17C43, PIC17CR43, and PIC17C44 devices, the need for a large general purpose memory space dictated a general purpose RAM banking scheme. The upper nibble of the BSR selects the currently active general purpose RAM bank. To assist this, a `MOVLB` bank instruction has been provided in the instruction set.

If the currently selected bank is not implemented (such as Bank 13), any read will read all '0's. Any write is completed to the bit bucket and the ALU status bits will be set/cleared as appropriate.

Note: Registers in Bank 15 in the Special Function Register area, are reserved for Microchip use. Reading of registers in this bank may cause random values to be read.

FIGURE 6-13: BSR OPERATION (PIC17C43/R43/44)



7.3 Table Reads

The table read allows the program memory to be read. This allows constant data to be stored in the program memory space, and retrieved into data memory when needed. Example 7-2 reads the 16-bit value at program memory address TBLPTR. After the dummy byte has been read from the TABLATH, the TABLATH is loaded with the 16-bit data from program memory address TBLPTR + 1. The first read loads the data into the latch, and can be considered a dummy read (unknown data loaded into 'f'). INDF0 should be configured for either auto-increment or auto-decrement.

EXAMPLE 7-2: TABLE READ

```
MOVLW    HIGH (TBL_ADDR) ; Load the Table
MOVWF    TBLPTRH          ; address
MOVLW    LOW  (TBL_ADDR) ;
MOVWF    TBLPTRL          ;
TABLRD   0,0,DUMMY        ; Dummy read,
                          ; Updates TABLATCH
TLRD     1, INDF0          ; Read HI byte
                          ; of TABLATCH
TABLRD   0,1,INDF0        ; Read LO byte
                          ; of TABLATCH and
                          ; Update TABLATCH
```

FIGURE 7-7: TABLRD TIMING

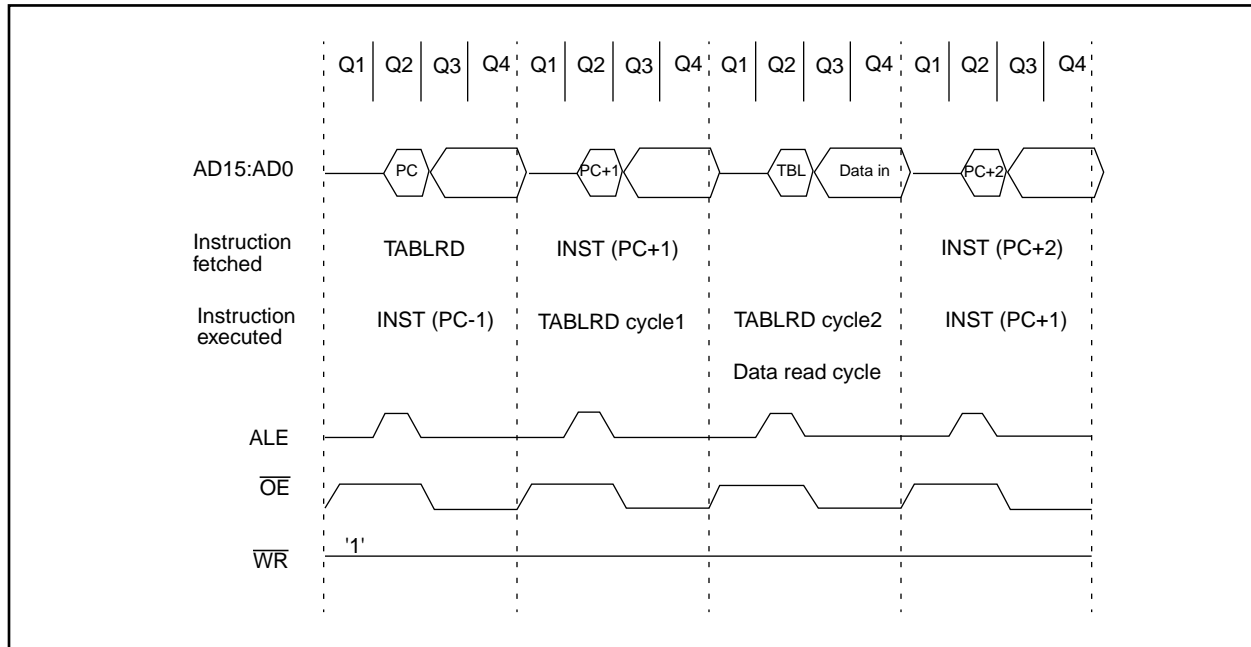
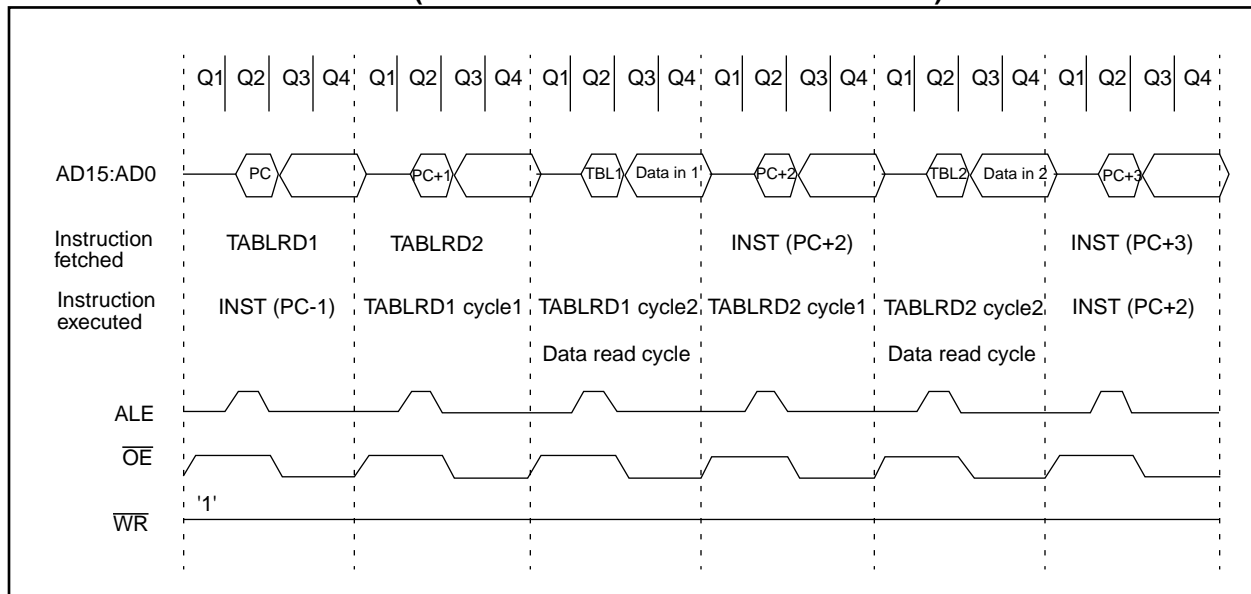


FIGURE 7-8: TABLRD TIMING (CONSECUTIVE TABLRD INSTRUCTIONS)



Example 8-4 shows the sequence to do an 16 x 16 signed multiply. Equation 8-2 shows the algorithm that used. The 32-bit result is stored in four registers RES3:RES0. To account for the sign bits of the arguments, each argument pairs most significant bit (MSb) is tested and the appropriate subtractions are done.

EQUATION 8-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

RES3:RES0

$$\begin{aligned}
 &= \text{ARG1H:ARG1L} * \text{ARG2H:ARG2L} \\
 &= (\text{ARG1H} * \text{ARG2H} * 2^{16}) &+ \\
 &\quad (\text{ARG1H} * \text{ARG2L} * 2^8) &+ \\
 &\quad (\text{ARG1L} * \text{ARG2H} * 2^8) &+ \\
 &\quad (\text{ARG1L} * \text{ARG2L}) &+ \\
 &\quad (-1 * \text{ARG2H} <7> * \text{ARG1H:ARG1L} * 2^{16}) &+ \\
 &\quad (-1 * \text{ARG1H} <7> * \text{ARG2H:ARG2L} * 2^{16})
 \end{aligned}$$

EXAMPLE 8-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```

MOVFP ARG1L, WREG
MULWF ARG2L      ; ARG1L * ARG2L ->
                  ; PRODH:PRODL

MOVFP PRODH, RES1 ;
MOVFP PRODL, RES0 ;

;

MOVFP ARG1H, WREG
MULWF ARG2H      ; ARG1H * ARG2H ->
                  ; PRODH:PRODL

MOVFP PRODH, RES3 ;
MOVFP PRODL, RES2 ;

;

MOVFP ARG1L, WREG
MULWF ARG2H      ; ARG1L * ARG2H ->
                  ; PRODH:PRODL

MOVFP PRODL, WREG ;
ADDWF RES1, F    ; Add cross
MOVFP PRODH, WREG ; products
ADDWFC RES2, F   ;
CLRf WREG, F     ;
ADDWFC RES3, F   ;

;

MOVFP ARG1H, WREG ;
MULWF ARG2L      ; ARG1H * ARG2L ->
                  ; PRODH:PRODL

MOVFP PRODL, WREG ;
ADDWF RES1, F    ; Add cross
MOVFP PRODH, WREG ; products
ADDWFC RES2, F   ;
CLRf WREG, F     ;
ADDWFC RES3, F   ;

;

BTfSS ARG2H, 7   ; ARG2H:ARG2L neg?
GOTO SIGN_ARG1  ; no, check ARG1
MOVFP ARG1L, WREG ;
SUBWF RES2      ;
MOVFP ARG1H, WREG ;
SUBWFB RES3     ;

;

SIGN_ARG1
BTfSS ARG1H, 7   ; ARG1H:ARG1L neg?
GOTO CONT_CODE  ; no, done
MOVFP ARG2L, WREG ;
SUBWF RES2      ;
MOVFP ARG2H, WREG ;
SUBWFB RES3     ;

;

CONT_CODE
:

```

FIGURE 9-2: RA2 AND RA3 BLOCK DIAGRAM

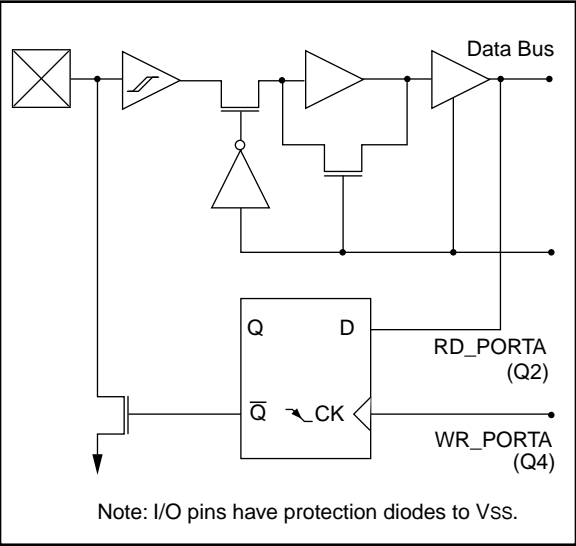


FIGURE 9-3: RA4 AND RA5 BLOCK DIAGRAM

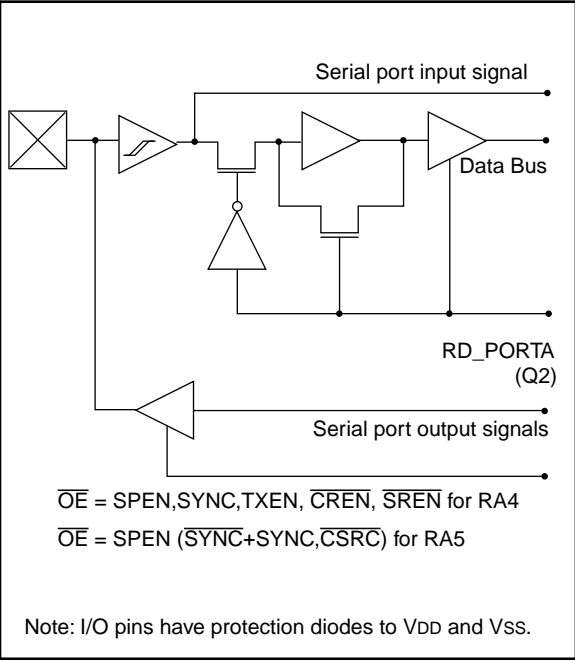


TABLE 9-1: PORTA FUNCTIONS

Name	Bit0	Buffer Type	Function
RA0/INT	bit0	ST	Input or external interrupt input.
RA1/T0CKI	bit1	ST	Input or clock input to the TMR0 timer/counter, and/or an external interrupt input.
RA2	bit2	ST	Input/Output. Output is open drain type.
RA3	bit3	ST	Input/Output. Output is open drain type.
RA4/RX/DT	bit4	ST	Input or USART Asynchronous Receive or USART Synchronous Data.
RA5/TX/CK	bit5	ST	Input or USART Asynchronous Transmit or USART Synchronous Clock.
RBPƯ	bit7	—	Control bit for PORTB weak pull-ups.

Legend: ST = Schmitt Trigger input.

TABLE 9-2: REGISTERS/BITS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
10h, Bank 0	PORTA	RBPƯ	—	RA5	RA4	RA3	RA2	RA1/T0CKI	RA0/INT	0-xx xxxx	0-uu uuuu
05h, Unbanked	T0STA	INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—	0000 000-	0000 000-
13h, Bank 0	RCSTA	SPEN	RC9	SREN	CREN	—	FERR	OERR	RC9D	0000 -00x	0000 -00u
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u

Legend: x = unknown, u = unchanged, - = unimplemented reads as '0'. Shaded cells are not used by PORTA.

Note 1: Other (non power-up) resets include: external reset through MCLR and the Watchdog Timer Reset.

NOTES:

TABLE 13-4: BAUD RATES FOR ASYNCHRONOUS MODE

BAUD RATE (K)	FOSC = 33 MHz			FOSC = 25 MHz			FOSC = 20 MHz			FOSC = 16 MHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	NA	—	—	NA	—	—
1.2	NA	—	—	NA	—	—	1.221	+1.73	255	1.202	+0.16	207
2.4	2.398	-0.07	214	2.396	0.14	162	2.404	+0.16	129	2.404	+0.16	103
9.6	9.548	-0.54	53	9.53	-0.76	40	9.469	-1.36	32	9.615	+0.16	25
19.2	19.09	-0.54	26	19.53	+1.73	19	19.53	+1.73	15	19.23	+0.16	12
76.8	73.66	-4.09	6	78.13	+1.73	4	78.13	+1.73	3	83.33	+8.51	2
96	103.12	+7.42	4	97.65	+1.73	3	104.2	+8.51	2	NA	—	—
300	257.81	-14.06	1	390.63	+30.21	0	312.5	+4.17	0	NA	—	—
500	515.62	+3.13	0	NA	—	—	NA	—	—	NA	—	—
HIGH	515.62	—	0	—	—	0	312.5	—	0	250	—	0
LOW	2.014	—	255	1.53	—	255	1.221	—	255	0.977	—	255

BAUD RATE (K)	FOSC = 10 MHz			FOSC = 7.159 MHz			FOSC = 5.068 MHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	NA	—	—	NA	—	—	0.31	+3.13	255
1.2	1.202	+0.16	129	1.203	-0.23	92	1.2	0	65
2.4	2.404	+0.16	64	2.380	-0.83	46	2.4	0	32
9.6	9.766	+1.73	15	9.322	-2.90	11	9.9	-3.13	7
19.2	19.53	+1.73	7	18.64	-2.90	5	19.8	+3.13	3
76.8	78.13	+1.73	1	NA	—	—	79.2	+3.13	0
96	NA	—	—	NA	—	—	NA	—	—
300	NA	—	—	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	156.3	—	0	111.9	—	0	79.2	—	0
LOW	0.610	—	255	0.437	—	255	0.309	—	255

BAUD RATE (K)	FOSC = 3.579 MHz			FOSC = 1 MHz			FOSC = 32.768 kHz		
	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)	KBAUD	%ERROR	SPBRG value (decimal)
0.3	0.301	+0.23	185	0.300	+0.16	51	0.256	-14.67	1
1.2	1.190	-0.83	46	1.202	+0.16	12	NA	—	—
2.4	2.432	+1.32	22	2.232	-6.99	6	NA	—	—
9.6	9.322	-2.90	5	NA	—	—	NA	—	—
19.2	18.64	-2.90	2	NA	—	—	NA	—	—
76.8	NA	—	—	NA	—	—	NA	—	—
96	NA	—	—	NA	—	—	NA	—	—
300	NA	—	—	NA	—	—	NA	—	—
500	NA	—	—	NA	—	—	NA	—	—
HIGH	55.93	—	0	15.63	—	0	0.512	—	0
LOW	0.218	—	255	0.061	—	255	0.002	—	255

13.2.2 USART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 13-4. The data comes in the RA4/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter operating at 16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc.

Once asynchronous mode is selected, reception is enabled by setting bit CREN (RCSTA<4>).

The heart of the receiver is the receive (serial) shift register (RSR). After sampling the stop bit, the received data in the RSR is transferred to the RCREG (if it is empty). If the transfer is complete, the interrupt bit RCIF (PIR<0>) is set. The actual interrupt can be enabled/disabled by setting/clearing the RCIE (PIE<0>) bit. RCIF is a read only bit which is cleared by the hardware. It is cleared when RCREG has been read and is empty. RCREG is a double buffered register; (i.e. it is a two deep FIFO). It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte begin shifting to the RSR. On detection of the stop bit of the third byte, if the RCREG is still full, then the overrun error bit, OERR (RCSTA<1>) will be set. The word in the RSR will be lost. RCREG can be read twice to retrieve the two bytes in the FIFO. The OERR bit has to be cleared in software which is done by resetting the receive logic (CREN is set). If the OERR bit is set, transfers from the RSR to RCREG are inhibited, so it is essential to clear the OERR bit if it is set. The framing error bit FERR (RCSTA<2>) is set if a stop bit is not detected.

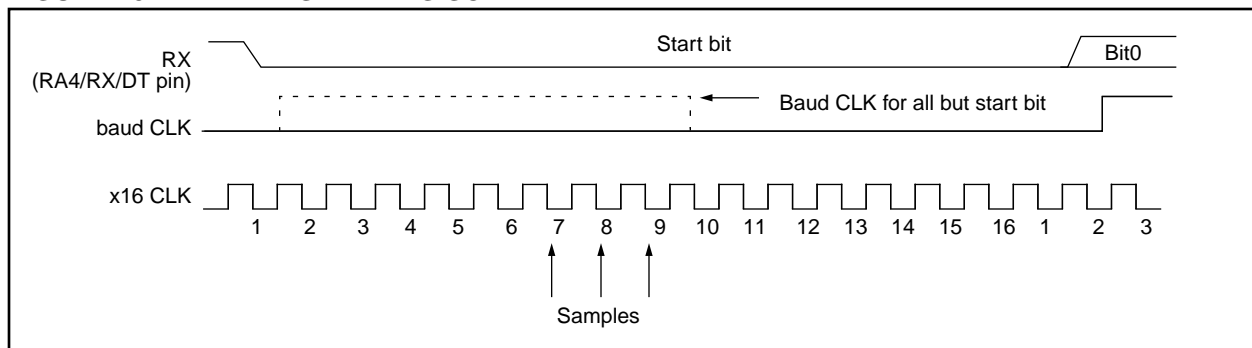
Note: The FERR and the 9th receive bit are buffered the same way as the receive data. Reading the RCREG register will allow the RX9D and FERR bits to be loaded with values for the next received Received data; therefore, it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

13.2.3 SAMPLING

The data on the RA4/RX/DT pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RA4/RX/DT pin. The sampling is done on the seventh, eighth and ninth falling edges of a x16 clock (Figure 11-3).

The x16 clock is a free running clock, and the three sample points occur at a frequency of every 16 falling edges.

FIGURE 13-7: RX PIN SAMPLING SCHEME



14.4.2 MINIMIZING CURRENT CONSUMPTION

To minimize current consumption, all I/O pins should be either at VDD, or VSS, with no external circuitry drawing current from the I/O pin. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should be at VDD or VSS. The contributions from on-chip pull-ups on PORTB should also be considered, and disabled when possible.

14.5 Code Protection

The code in the program memory can be protected by selecting the microcontroller in code protected mode (PM2:PM0 = '000').

Note: PM2 does not exist on the PIC17C42. To select code protected microcontroller mode, PM1:PM0 = '00'.

In this mode, instructions that are in the on-chip program memory space, can continue to read or write the program memory. An instruction that is executed outside of the internal program memory range will be inhibited from writing to or reading from program memory.

Note: Microchip does not recommend code protecting windowed devices.

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

TABLE 15-2: PIC17CXX INSTRUCTION SET

Mnemonic, Operands	Description	Cycles	16-bit Opcode		Status Affected	Notes
			MSb	LSb		
BYTE-ORIENTED FILE REGISTER OPERATIONS						
ADDWF	f,d	ADD WREG to f	1	0000 111d ffff ffff	OV,C,DC,Z	
ADDWFC	f,d	ADD WREG and Carry bit to f	1	0001 000d ffff ffff	OV,C,DC,Z	
ANDWF	f,d	AND WREG with f	1	0000 101d ffff ffff	Z	
CLRF	f,s	Clear f, or Clear f and Clear WREG	1	0010 100s ffff ffff	None	3
COMF	f,d	Complement f	1	0001 001d ffff ffff	Z	
CPFSEQ	f	Compare f with WREG, skip if f = WREG	1 (2)	0011 0001 ffff ffff	None	6,8
CPFSGT	f	Compare f with WREG, skip if f > WREG	1 (2)	0011 0010 ffff ffff	None	2,6,8
CPFSLT	f	Compare f with WREG, skip if f < WREG	1 (2)	0011 0000 ffff ffff	None	2,6,8
DAW	f,s	Decimal Adjust WREG Register	1	0010 111s ffff ffff	C	3
DECF	f,d	Decrement f	1	0000 011d ffff ffff	OV,C,DC,Z	
DECFSZ	f,d	Decrement f, skip if 0	1 (2)	0001 011d ffff ffff	None	6,8
DCFSNZ	f,d	Decrement f, skip if not 0	1 (2)	0010 011d ffff ffff	None	6,8
INCF	f,d	Increment f	1	0001 010d ffff ffff	OV,C,DC,Z	
INCFSZ	f,d	Increment f, skip if 0	1 (2)	0001 111d ffff ffff	None	6,8
INFSNZ	f,d	Increment f, skip if not 0	1 (2)	0010 010d ffff ffff	None	6,8
IORWF	f,d	Inclusive OR WREG with f	1	0000 100d ffff ffff	Z	
MOVFP	f,p	Move f to p	1	011p pppp ffff ffff	None	
MOVPF	p,f	Move p to f	1	010p pppp ffff ffff	Z	
MOVWF	f	Move WREG to f	1	0000 0001 ffff ffff	None	
MULWF	f	Multiply WREG with f	1	0011 0100 ffff ffff	None	9
NEGW	f,s	Negate WREG	1	0010 110s ffff ffff	OV,C,DC,Z	1,3
NOP	—	No Operation	1	0000 0000 0000 0000	None	
RLCF	f,d	Rotate left f through Carry	1	0001 101d ffff ffff	C	
RLNCF	f,d	Rotate left f (no carry)	1	0010 001d ffff ffff	None	
RRCF	f,d	Rotate right f through Carry	1	0001 100d ffff ffff	C	
RRNCF	f,d	Rotate right f (no carry)	1	0010 000d ffff ffff	None	
SETF	f,s	Set f	1	0010 101s ffff ffff	None	3
SUBWF	f,d	Subtract WREG from f	1	0000 010d ffff ffff	OV,C,DC,Z	1
SUBWFB	f,d	Subtract WREG from f with Borrow	1	0000 001d ffff ffff	OV,C,DC,Z	1
SWAPF	f,d	Swap f	1	0001 110d ffff ffff	None	
TABLRD	t,i,f	Table Read	2 (3)	1010 10ti ffff ffff	None	7

Legend: Refer to Table 15-1 for opcode field descriptions.

Note 1: 2's Complement method.

2: Unsigned arithmetic.

3: If s = '1', only the file is affected: If s = '0', both the WREG register and the file are affected; If only the Working register (WREG) is required to be affected, then f = WREG must be specified.

4: During an **LCALL**, the contents of PCLATH are loaded into the MSB of the PC and kkkk kkkk is loaded into the LSB of the PC (PCL)

5: Multiple cycle instruction for EPROM programming when table pointer selects internal EPROM. The instruction is terminated by an interrupt event. When writing to external program memory, it is a two-cycle instruction.

6: Two-cycle instruction when condition is true, else single cycle instruction.

7: Two-cycle instruction except for **TABLRD** to PCL (program counter low byte) in which case it takes 3 cycles.

8: A "skip" means that instruction fetched during execution of current instruction is not executed, instead an NOP is executed.

9: These instructions are not available on the PIC17C42.

TABLE 15-2: PIC17CXX INSTRUCTION SET (Cont'd)

Mnemonic, Operands	Description	Cycles	16-bit Opcode		Status Affected	Notes
			MSb	LSb		
TABLWT t,i,f	Table Write	2	1010	11ti ffff ffff	None	5
TLRD t,f	Table Latch Read	1	1010	00tx ffff ffff	None	
TLWT t,f	Table Latch Write	1	1010	01tx ffff ffff	None	
TSTFSZ f	Test f, skip if 0	1 (2)	0011	0011 ffff ffff	None	6,8
XORWF f,d	Exclusive OR WREG with f	1	0000	110d ffff ffff	Z	
BIT-ORIENTED FILE REGISTER OPERATIONS						
BCF f,b	Bit Clear f	1	1000	1bbb ffff ffff	None	
BSF f,b	Bit Set f	1	1000	0bbb ffff ffff	None	
BTFSC f,b	Bit test, skip if clear	1 (2)	1001	1bbb ffff ffff	None	6,8
BTFSS f,b	Bit test, skip if set	1 (2)	1001	0bbb ffff ffff	None	6,8
BTG f,b	Bit Toggle f	1	0011	1bbb ffff ffff	None	
LITERAL AND CONTROL OPERATIONS						
ADDLW k	ADD literal to WREG	1	1011	0001 kkkk kkkk	OV,C,DC,Z	
ANDLW k	AND literal with WREG	1	1011	0101 kkkk kkkk	Z	
CALL k	Subroutine Call	2	111k	kkkk kkkk kkkk	None	7
CLRWDT —	Clear Watchdog Timer	1	0000	0000 0000 0100	$\overline{TO}, \overline{PD}$	
GOTO k	Unconditional Branch	2	110k	kkkk kkkk kkkk	None	7
IORLW k	Inclusive OR literal with WREG	1	1011	0011 kkkk kkkk	Z	
LCALL k	Long Call	2	1011	0111 kkkk kkkk	None	4,7
MOVLB k	Move literal to low nibble in BSR	1	1011	1000 uuuu kkkk	None	
MOVLR k	Move literal to high nibble in BSR	1	1011	101x kkkk uuuu	None	9
MOVLW k	Move literal to WREG	1	1011	0000 kkkk kkkk	None	
MULLW k	Multiply literal with WREG	1	1011	1100 kkkk kkkk	None	9
RETFIE —	Return from interrupt (and enable interrupts)	2	0000	0000 0000 0101	GLINTD	7
RETLW k	Return literal to WREG	2	1011	0110 kkkk kkkk	None	7
RETURN —	Return from subroutine	2	0000	0000 0000 0010	None	7
SLEEP —	Enter SLEEP Mode	1	0000	0000 0000 0011	$\overline{TO}, \overline{PD}$	
SUBLW k	Subtract WREG from literal	1	1011	0010 kkkk kkkk	OV,C,DC,Z	
XORLW k	Exclusive OR literal with WREG	1	1011	0100 kkkk kkkk	Z	

Legend: Refer to Table 15-1 for opcode field descriptions.

Note 1: 2's Complement method.

2: Unsigned arithmetic.

3: If s = '1', only the file is affected; If s = '0', both the WREG register and the file are affected; If only the Working register (WREG) is required to be affected, then f = WREG must be specified.

4: During an **LCALL**, the contents of PCLATH are loaded into the MSB of the PC and kkkk kkkk is loaded into the LSB of the PC (PCL)

5: Multiple cycle instruction for EPROM programming when table pointer selects internal EPROM. The instruction is terminated by an interrupt event. When writing to external program memory, it is a two-cycle instruction.

6: Two-cycle instruction when condition is true, else single cycle instruction.

7: Two-cycle instruction except for **TABLRD** to PCL (program counter low byte) in which case it takes 3 cycles.

8: A "skip" means that instruction fetched during execution of current instruction is not executed, instead an NOP is executed.

9: These instructions are not available on the PIC17C42.

MOVLR	Move Literal to high nibble in BSR			
Syntax:	[<i>label</i>] MOVLR k			
Operands:	$0 \leq k \leq 15$			
Operation:	$k \rightarrow (\text{BSR} \langle 7:4 \rangle)$			
Status Affected:	None			
Encoding:	1011	101x	kkkk	uuuu
Description:	The 4-bit literal 'k' is loaded into the most significant 4-bits of the Bank Select Register (BSR). Only the high 4-bits of the Bank Select Register are affected. The lower half of the BSR is unchanged. The assembler will encode the “u” fields as 0.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				

Q1	Q2	Q3	Q4
Decode	Read literal 'k:u'	Execute	Write literal 'k' to BSR<7:4>

Example: MOVLR 5

Before Instruction

BSR register = 0x22

After Instruction

BSR register = 0x52

Note: This instruction is not available in the PIC17C42 device.

MOVLW	Move Literal to WREG				
Syntax:	[<i>label</i>] MOVLW k				
Operands:	$0 \leq k \leq 255$				
Operation:	$k \rightarrow (\text{WREG})$				
Status Affected:	None				
Encoding:	<table><tr><td>1011</td><td>0000</td><td>kkkk</td><td>kkkk</td></tr></table>	1011	0000	kkkk	kkkk
1011	0000	kkkk	kkkk		
Description:	The eight bit literal 'k' is loaded into WREG.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Execute	Write to WREG

Example: MOVLW 0x5A

After Instruction

WREG = 0x5A

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FIGURE 17-1: PARAMETER MEASUREMENT INFORMATION

All timings are measure between high and low measurement points as indicated in the figures below.

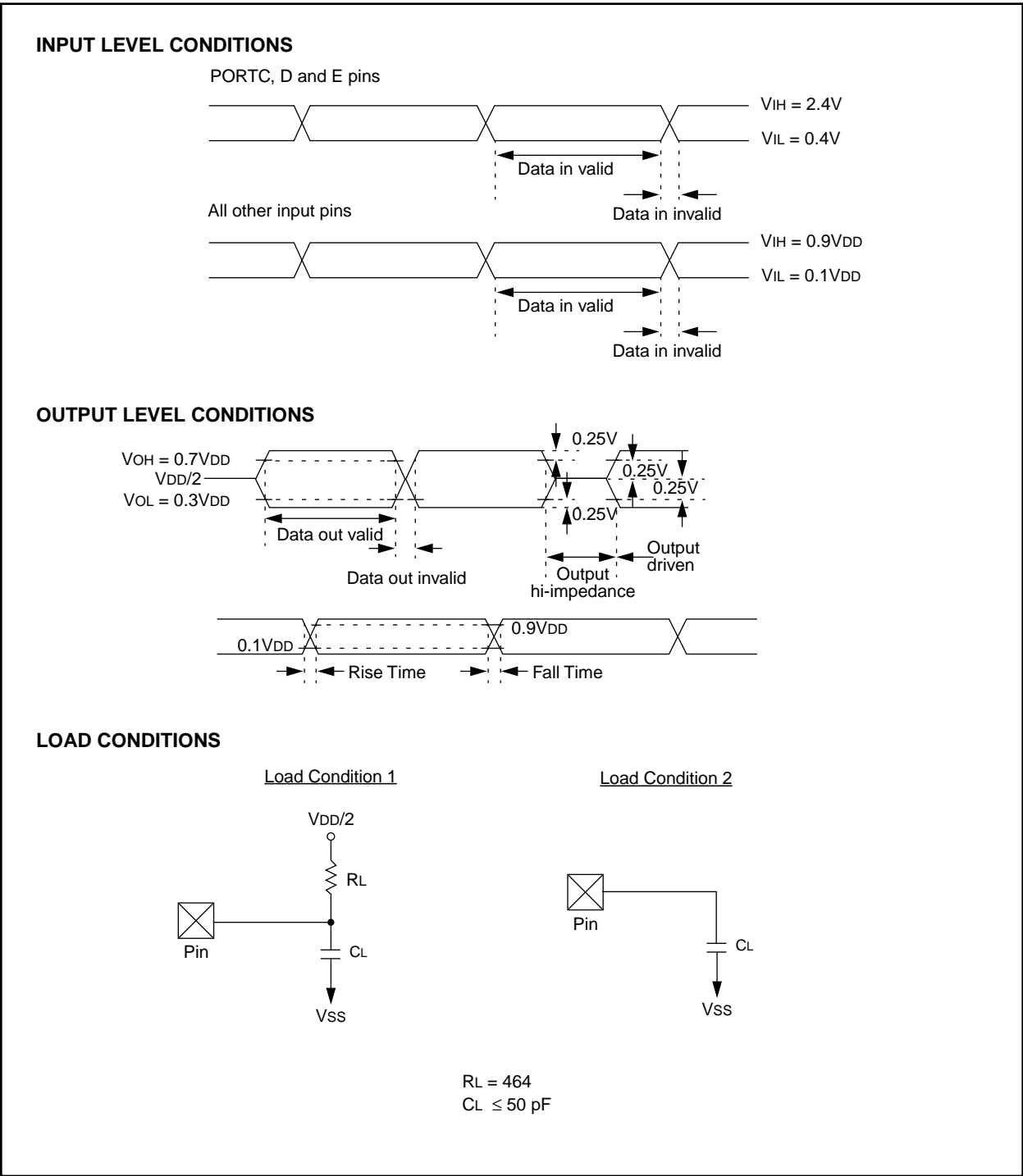


FIGURE 18-15: I_{OH} vs. V_{OH} , $V_{DD} = 5V$

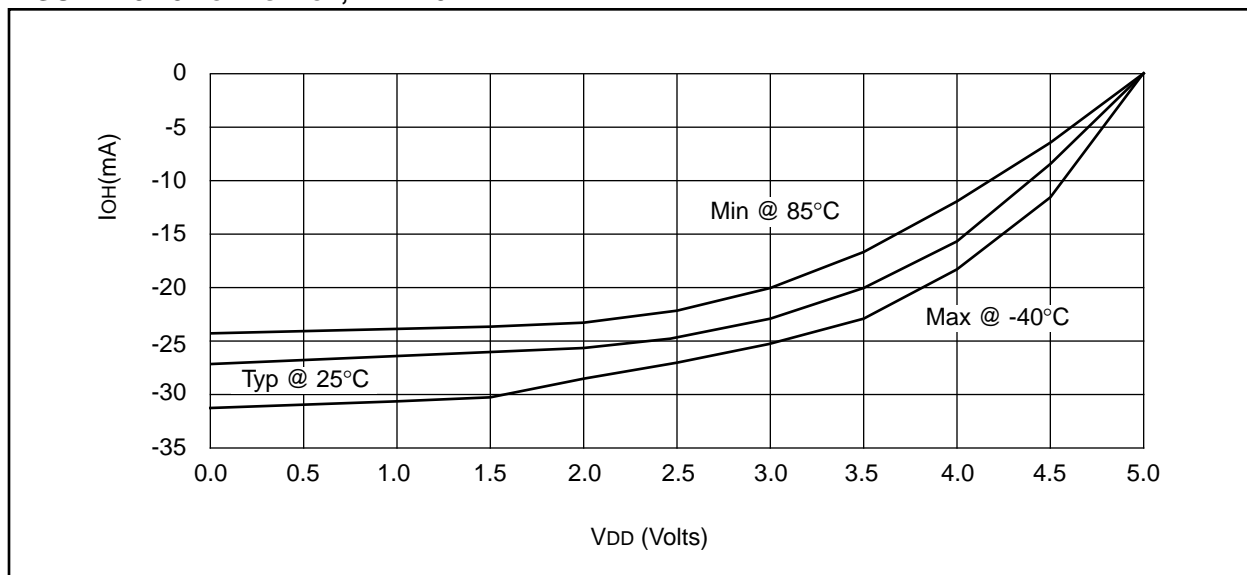
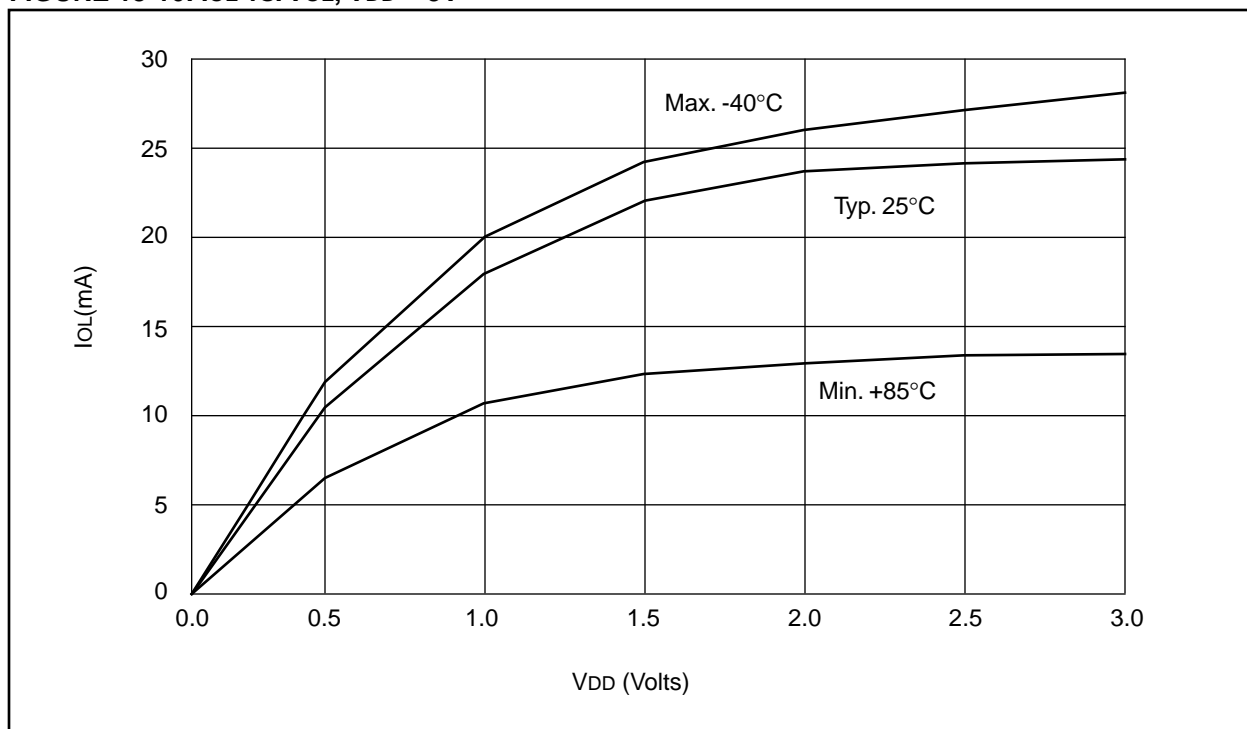


FIGURE 18-16: I_{OL} vs. V_{OL} , $V_{DD} = 3V$



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FIGURE 19-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, AND POWER-UP TIMER TIMING

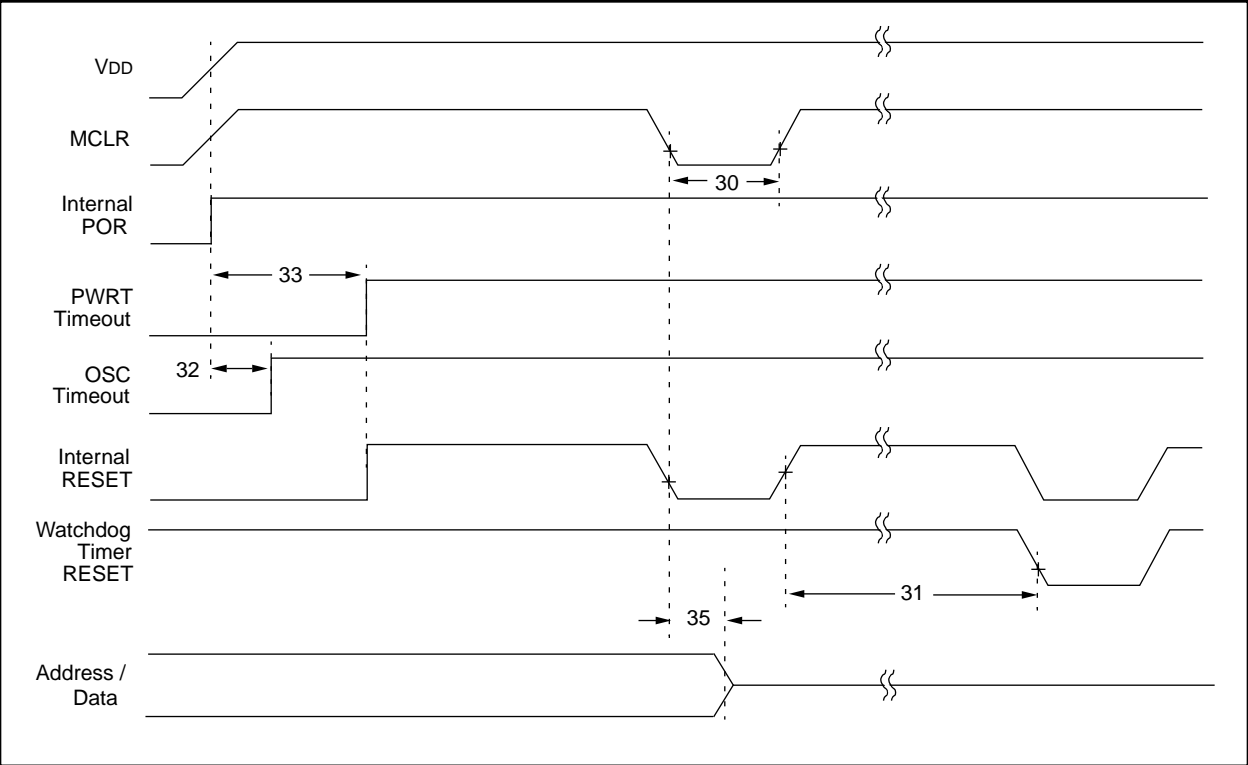


TABLE 19-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	Tmcl	MCLR Pulse Width (low)	100 *	—	—	ns	VDD = 5V
31	Twdt	Watchdog Timer Time-out Period (Prescale = 1)	5 *	12	25 *	ms	VDD = 5V
32	Tost	Oscillation Start-up Timer Period	—	1024Tosc§	—	ms	Tosc = OSC1 period
33	Tpwrt	Power-up Timer Period	40 *	96	200 *	ms	VDD = 5V
35	Tmcl2adl	MCLR to System Interface bus (AD15:AD0>) invalid					
		PIC17CR42/42A/43/R43/44	—	—	100 *	ns	
		PIC17LCR42/42A/43/R43/44	—	—	120 *	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

§ This specification ensured by design.

FIGURE 19-12: MEMORY INTERFACE READ TIMING (NOT SUPPORTED IN PIC17LC4X DEVICES)

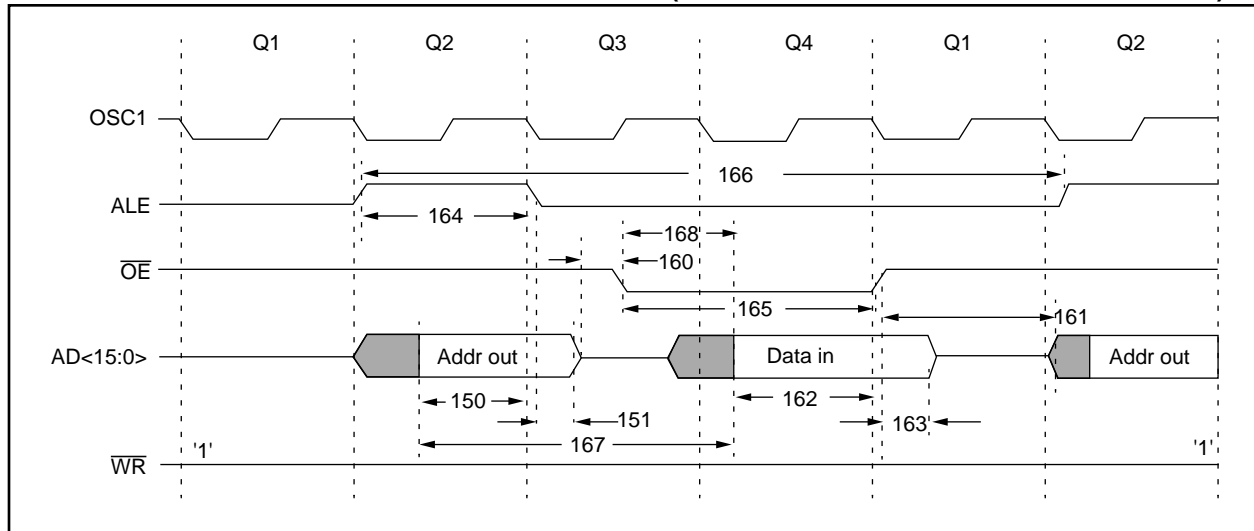


TABLE 19-12: MEMORY INTERFACE READ REQUIREMENTS (NOT SUPPORTED IN PIC17LC4X DEVICES)

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
150	TadV2alL	AD15:AD0 (address) valid to ALE↓ (address setup time)	0.25Tcy - 10	—	—	ns	
151	TalL2adI	ALE↓ to address out invalid (address hold time)	5*	—	—	ns	
160	TadZ2oeL	AD15:AD0 hi-impedance to \overline{OE} ↓	0*	—	—	ns	
161	ToeH2adD	\overline{OE} ↑ to AD15:AD0 driven	0.25Tcy - 15	—	—	ns	
162	TadV2oeH	Data in valid before \overline{OE} ↑ (data setup time)	35	—	—	ns	
163	ToeH2adI	\overline{OE} ↑ to data in invalid (data hold time)	0	—	—	ns	
164	TalH	ALE pulse width	—	0.25Tcy §	—	ns	
165	ToeL	\overline{OE} pulse width	0.5Tcy - 35 §	—	—	ns	
166	TalH2alH	ALE↑ to ALE↑ (cycle time)	—	Tcy §	—	ns	
167	Tacc	Address access time	—	—	0.75Tcy - 30	ns	
168	Toe	Output enable access time (\overline{OE} low to Data Valid)	—	—	0.5Tcy - 45	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

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FIGURE 20-17: I_{OH} vs. V_{OL} , $V_{DD} = 5V$

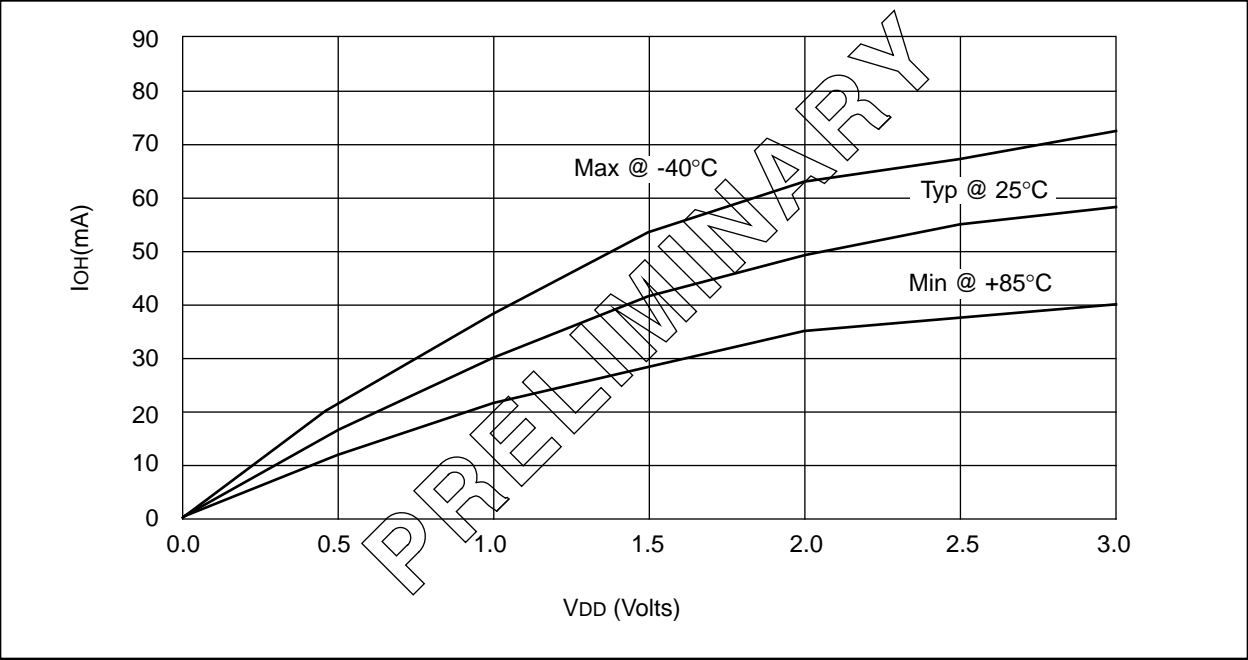


FIGURE 20-18: V_{TH} (INPUT THRESHOLD VOLTAGE) OF I/O PINS (TTL) vs. V_{DD}

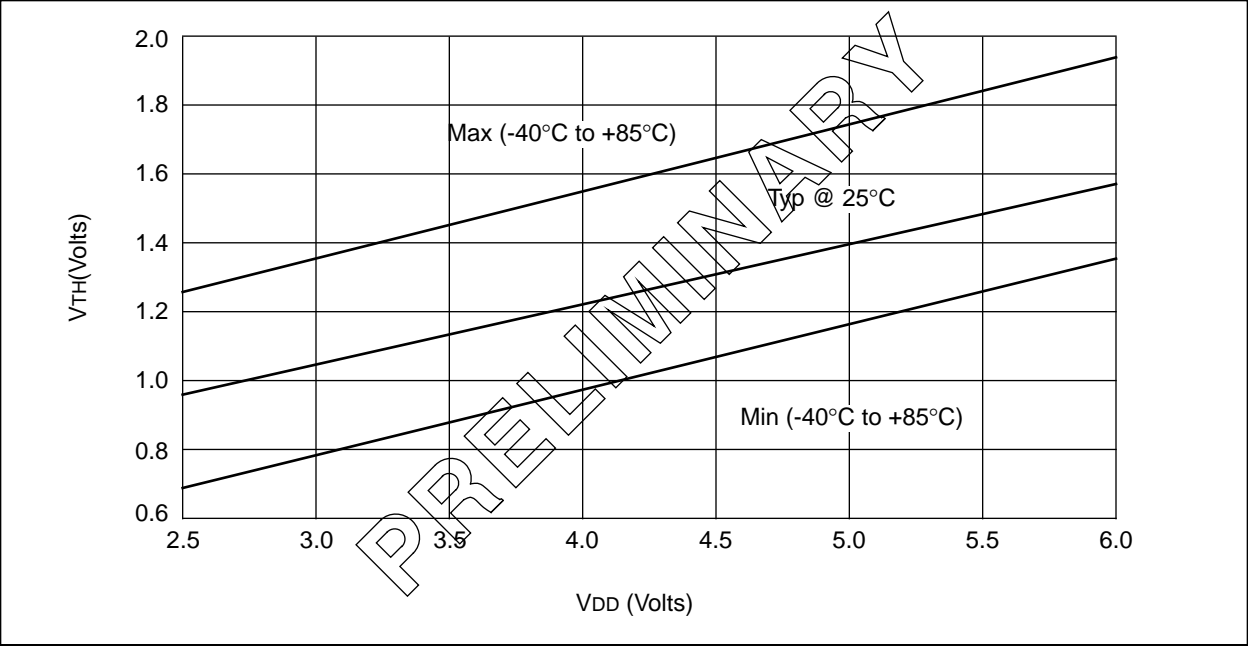


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